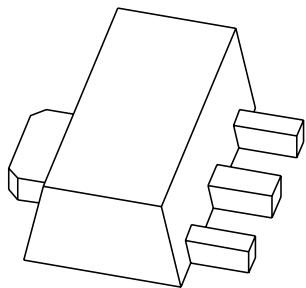


# DATA SHEET



**PBSS4350X**  
**50 V, 3 A**  
**NPN low  $V_{CEsat}$  (BISS) transistor**

Product specification  
Supersedes data of 2003 Nov 21

2004 Nov 04

# 50 V, 3 A NPN low $V_{CEsat}$ (BISS) transistor

PBSS4350X

**FEATURES**

- SOT89 (SC-62) package
- Low collector-emitter saturation voltage  $V_{CEsat}$
- High collector current capability:  $I_C$  and  $I_{CM}$
- Higher efficiency leading to less heat generation
- Reduced printed-circuit board requirements.

**QUICK REFERENCE DATA**

SYMBOL	PARAMETER	MAX.	UNIT
$V_{CEO}$	collector-emitter voltage	50	V
$I_C$	collector current (DC)	3	A
$I_{CM}$	peak collector current	5	A
$R_{CEsat}$	equivalent on-resistance	130	$m\Omega$

**APPLICATIONS**

- Power management
  - DC/DC converters
  - Supply line switching
  - Battery charger
  - LCD backlighting.
- Peripheral drivers
  - Driver in low supply voltage applications (e.g. lamps and LEDs).
  - Inductive load driver (e.g. relays, buzzers and motors).

**PINNING**

PIN	DESCRIPTION
1	emitter
2	collector
3	base

**DESCRIPTION**

NPN low  $V_{CEsat}$  transistor in a SOT89 plastic package.  
PNP complement: PBSS5350X.

**MARKING**

TYPE NUMBER	MARKING CODE
PBSS4350X	S43

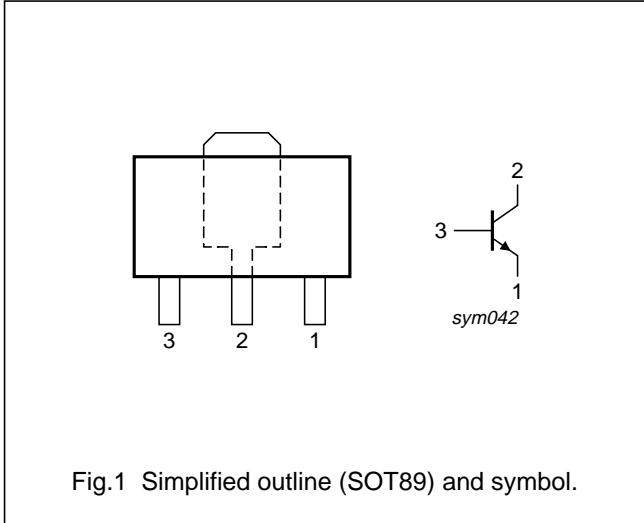


Fig.1 Simplified outline (SOT89) and symbol.

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**PBSS4350X**

**ORDERING INFORMATION**

<b>TYPE NUMBER</b>	<b>PACKAGE</b>		
	<b>NAME</b>	<b>DESCRIPTION</b>	<b>VERSION</b>
PBSS4350X	SC-62	plastic surface mounted package; collector pad for good heat transfer; 3 leads	SOT89

**LIMITING VALUES**

In accordance with the Absolute Maximum Rating System (IEC 60134).

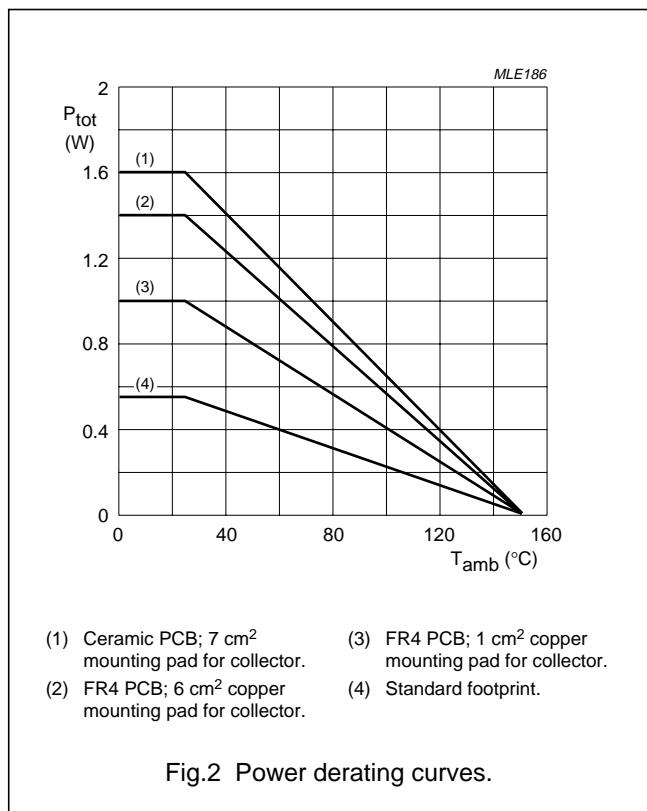
<b>SYMBOL</b>	<b>PARAMETER</b>	<b>CONDITIONS</b>	<b>MIN.</b>	<b>MAX.</b>	<b>UNIT</b>
$V_{CBO}$	collector-base voltage	open emitter	—	50	V
$V_{CEO}$	collector-emitter voltage	open base	—	50	V
$V_{EBO}$	emitter-base voltage	open collector	—	5	V
$I_C$	collector current (DC)	note 4	—	3	A
$I_{CM}$	peak collector current	limited by $T_{j(max)}$	—	5	A
$I_B$	base current (DC)		—	0.5	A
$P_{tot}$	total power dissipation	$T_{amb} \leq 25^\circ\text{C}$ note 1 note 2 note 3 note 4		550 1 1.4 1.6	mW W W W
$T_{stg}$	storage temperature		-65	+150	°C
$T_j$	junction temperature		—	150	°C
$T_{amb}$	ambient temperature		-65	+150	°C

**Notes**

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.

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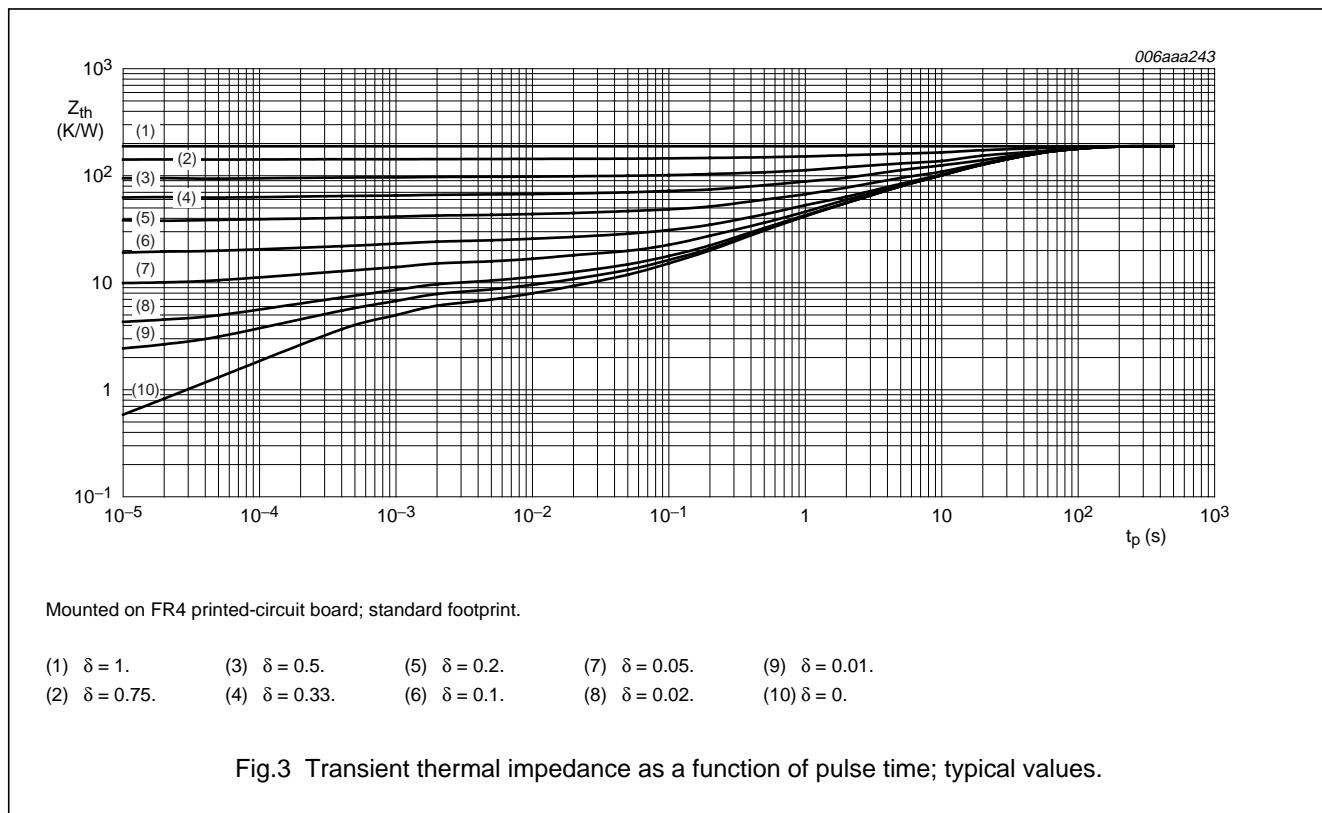
**PBSS4350X**

**THERMAL CHARACTERISTICS**

SYMBOL	PARAMETER	CONDITIONS	VALUE	UNIT
$R_{th(j-a)}$	thermal resistance from junction to ambient	in free air note 1 note 2 note 3 note 4	225 125 90 80	K/W
$R_{th(j-s)}$	thermal resistance from junction to soldering point		16	K/W

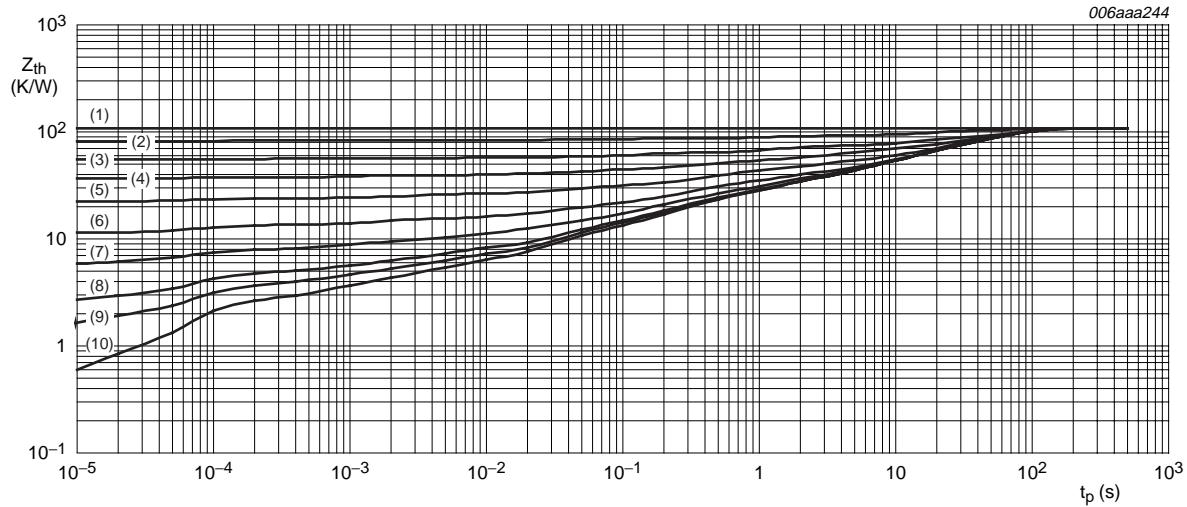
**Notes**

1. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; standard footprint.
2. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 1 cm<sup>2</sup>.
3. Device mounted on a FR4 printed-circuit board; single-sided copper; tin-plated; mounting pad for collector 6 cm<sup>2</sup>.
4. Device mounted on a ceramic printed-circuit board 7 cm<sup>2</sup>, single-sided copper, tin-plated.



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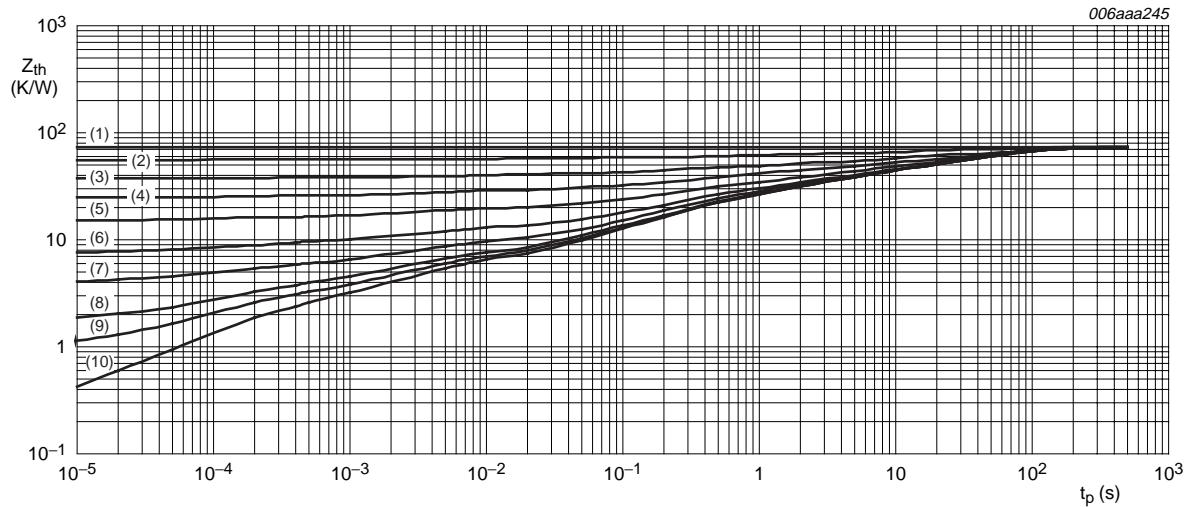
**PBSS4350X**



Mounted on FR4 printed-circuit board; mounting pad for collector  $1 \text{ cm}^2$ .

- |                      |                      |                     |                      |                      |
|----------------------|----------------------|---------------------|----------------------|----------------------|
| (1) $\delta = 1.$    | (3) $\delta = 0.5.$  | (5) $\delta = 0.2.$ | (7) $\delta = 0.05.$ | (9) $\delta = 0.01.$ |
| (2) $\delta = 0.75.$ | (4) $\delta = 0.33.$ | (6) $\delta = 0.1.$ | (8) $\delta = 0.02.$ | (10) $\delta = 0.$   |

Fig.4 Transient thermal impedance as a function of pulse time; typical values.



Mounted on FR4 printed-circuit board; mounting pad for collector  $6 \text{ cm}^2$ .

- |                      |                      |                     |                      |                      |
|----------------------|----------------------|---------------------|----------------------|----------------------|
| (1) $\delta = 1.$    | (3) $\delta = 0.5.$  | (5) $\delta = 0.2.$ | (7) $\delta = 0.05.$ | (9) $\delta = 0.01.$ |
| (2) $\delta = 0.75.$ | (4) $\delta = 0.33.$ | (6) $\delta = 0.1.$ | (8) $\delta = 0.02.$ | (10) $\delta = 0.$   |

Fig.5 Transient thermal impedance as a function of pulse time; typical values.

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**CHARACTERISTICS**

$T_{amb} = 25^\circ\text{C}$  unless otherwise specified.

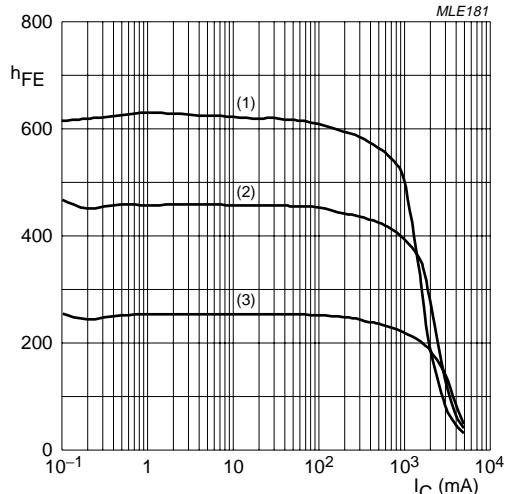
SYMBOL	PARAMETER	CONDITIONS	MIN.	TYP.	MAX.	UNIT
$I_{CBO}$	collector-base cut-off current	$V_{CB} = 50\text{ V}; I_E = 0\text{ A}$	—	—	100	nA
		$V_{CB} = 50\text{ V}; I_E = 0\text{ A}; T_j = 150^\circ\text{C}$	—	—	50	$\mu\text{A}$
$I_{CES}$	collector-emitter cut-off current	$V_{CE} = 50\text{ V}; V_{BE} = 0\text{ V}$	—	—	100	nA
$I_{EBO}$	emitter-base cut-off current	$V_{EB} = 5\text{ V}; I_C = 0\text{ A}$	—	—	100	nA
$h_{FE}$	DC current gain	$V_{CE} = 2\text{ V}$				
		$I_C = 0.1\text{ A}$	300	—	—	
		$I_C = 0.5\text{ A}$	300	—	—	
		$I_C = 1\text{ A}; \text{note 1}$	300	—	700	
		$I_C = 2\text{ A}; \text{note 1}$	200	—	—	
		$I_C = 3\text{ A}; \text{note 1}$	100	—	—	
$V_{CEsat}$	collector-emitter saturation voltage	$I_C = 0.5\text{ A}; I_B = 50\text{ mA}$	—	—	80	mV
		$I_C = 1\text{ A}; I_B = 50\text{ mA}$	—	—	160	mV
		$I_C = 2\text{ A}; I_B = 100\text{ mA}$	—	—	280	mV
		$I_C = 2\text{ A}; I_B = 200\text{ mA}; \text{note 1}$	—	—	260	mV
		$I_C = 3\text{ A}; I_B = 300\text{ mA}; \text{note 1}$	—	—	370	mV
$R_{CEsat}$	equivalent on-resistance	$I_C = 2\text{ A}; I_B = 200\text{ mA}; \text{note 1}$	—	100	130	$\text{m}\Omega$
$V_{BEsat}$	base-emitter saturation voltage	$I_C = 2\text{ A}; I_B = 100\text{ mA}$	—	—	1.1	V
		$I_C = 3\text{ A}; I_B = 300\text{ mA}; \text{note 1}$	—	—	1.2	V
$V_{BEon}$	base-emitter turn-on voltage	$V_{CE} = 2\text{ V}; I_C = 1\text{ A}$	1.1	—	—	V
$f_T$	transition frequency	$I_C = 100\text{ mA}; V_{CE} = 5\text{ V}; f = 100\text{ MHz}$	100	—	—	MHz
$C_c$	collector capacitance	$V_{CB} = 10\text{ V}; I_E = i_e = 0\text{ A}; f = 1\text{ MHz}$	—	—	25	pF

**Note**

1. Pulse test:  $t_p \leq 300\text{ }\mu\text{s}; \delta \leq 0.02$ .

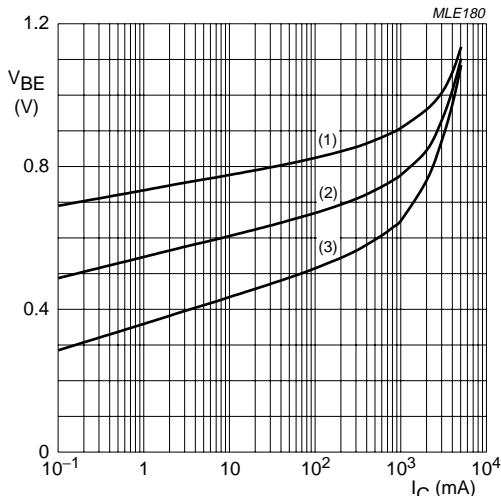
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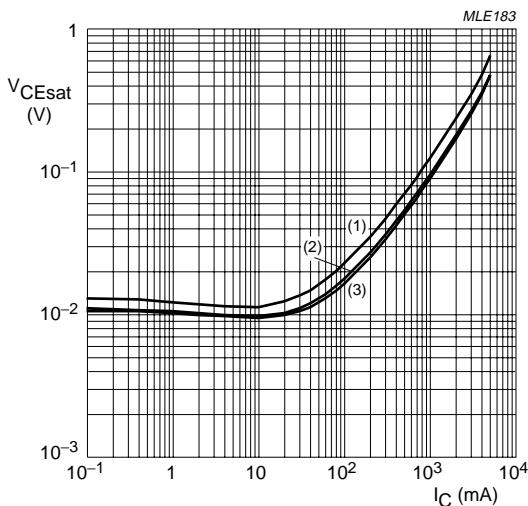
$V_{CE} = 2$  V.  
(1)  $T_{amb} = 100$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = -55$  °C.

Fig.6 DC current gain as a function of collector current; typical values.



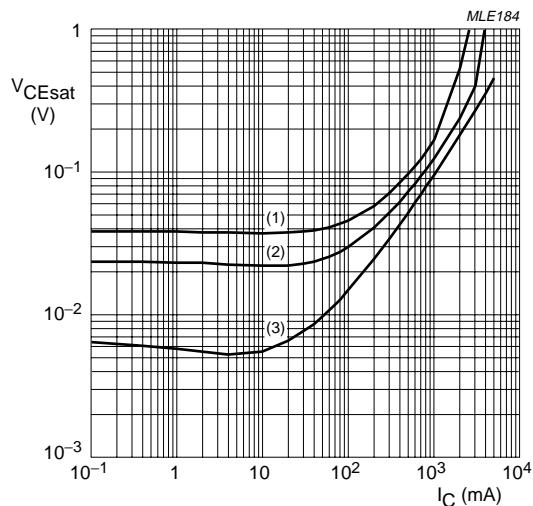
$V_{CE} = 2$  V.  
(1)  $T_{amb} = -55$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = 100$  °C.

Fig.7 Base-emitter voltage as a function of collector current; typical values.



$I_C/I_B = 20$ .  
(1)  $T_{amb} = 100$  °C.  
(2)  $T_{amb} = 25$  °C.  
(3)  $T_{amb} = -55$  °C.

Fig.8 Collector-emitter saturation voltage as a function of collector current; typical values.

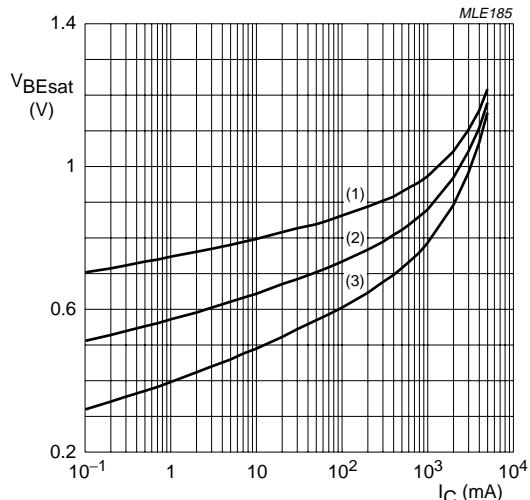


$T_{amb} = 25$  °C.  
(1)  $I_C/I_B = 100$ .  
(2)  $I_C/I_B = 50$ .  
(3)  $I_C/I_B = 10$ .

Fig.9 Collector-emitter saturation voltage as a function of collector current; typical values.

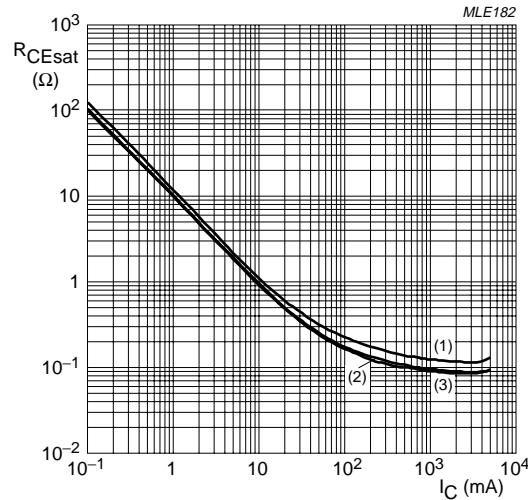
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$I_C/I_B = 20$ .

Fig.10 Base-emitter saturation voltage as a function of collector current; typical values.



$I_C/I_B = 20$ .

Fig.11 Equivalent on-resistance as a function of collector current; typical values.

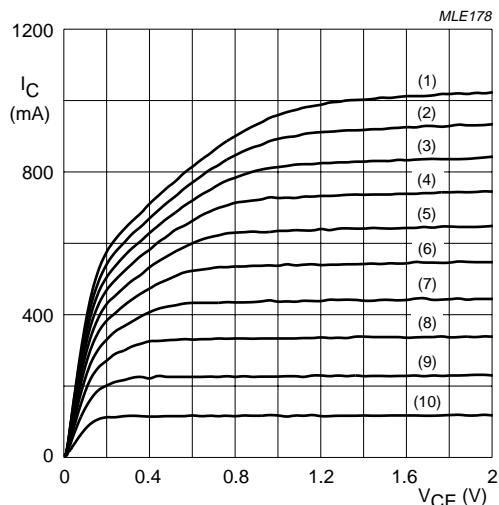


Fig.12 Collector current as a function of collector-emitter voltage; typical values.

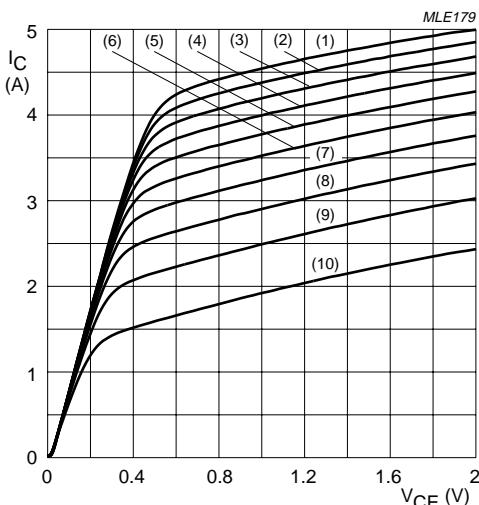


Fig.13 Collector current as a function of collector-emitter voltage; typical values.

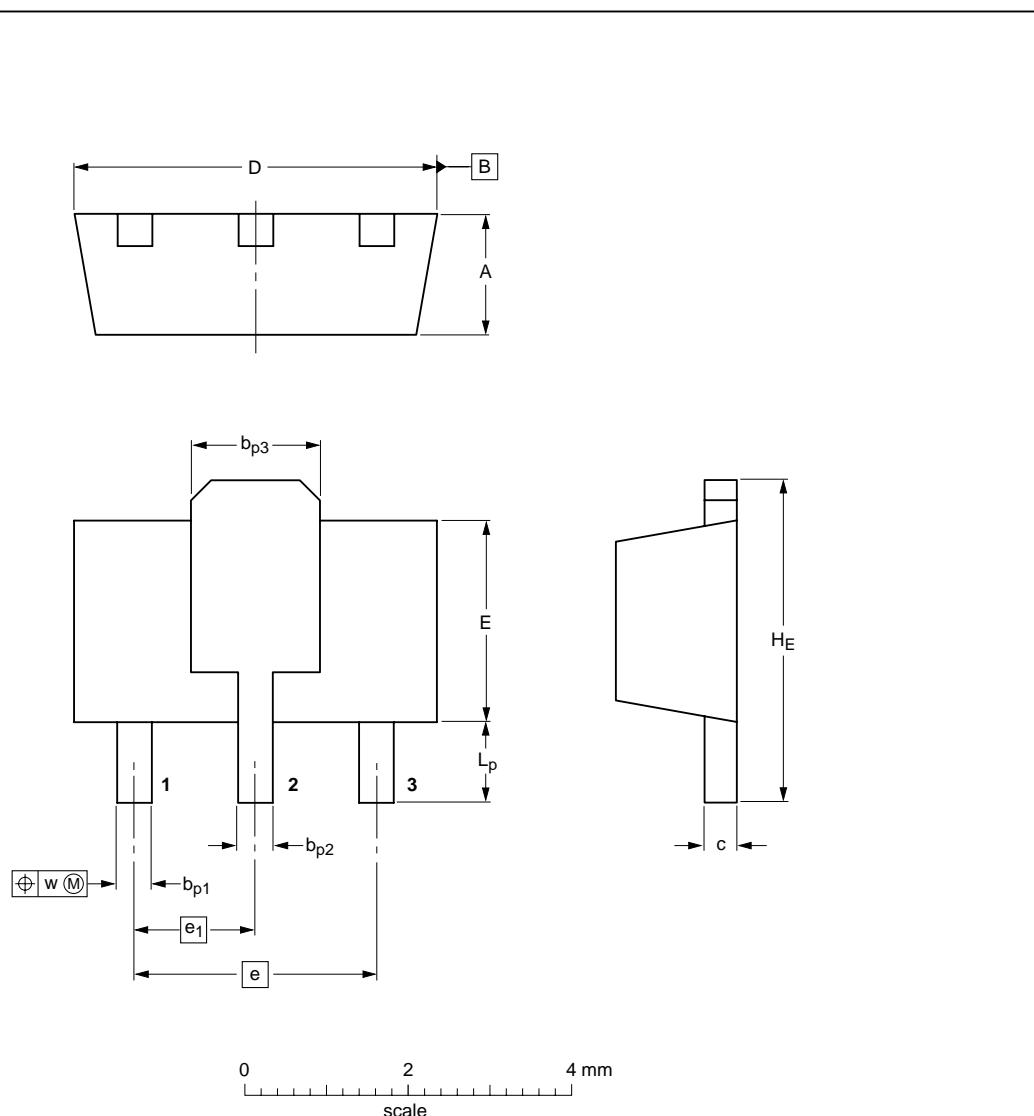
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**PACKAGE OUTLINE**

Plastic surface mounted package; collector pad for good heat transfer; 3 leads

SOT89



**DIMENSIONS (mm are the original dimensions)**

UNIT	A	b <sub>p1</sub>	b <sub>p2</sub>	b <sub>p3</sub>	c	D	E	e	e <sub>1</sub>	H <sub>E</sub>	L <sub>p</sub>	w
mm	1.6 1.4	0.48 0.35	0.53 0.40	1.8 1.4	0.44 0.23	4.6 4.4	2.6 2.4	3.0	1.5	4.25 3.75	1.2 0.8	0.13

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	JEITA			
SOT89		TO-243	SC-62			-99-09-13-04-08-03